Renesas Electronics America Inc - R5F563TEADFH#V1 Datasheet

Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, EBI/EMI, I²C, LINbus, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	69
Program Memory Size	512KB (512K x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	48K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 12x10b, 8x12b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	112-LQFP
Supplier Device Package	112-LQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f563teadfh-v1

Table 1.7 List of Pins and Pin Functions (112-Pin LQFP) (2/4)

Pin Number 112-Pin LQFP	Power Supply Clock System Control	I/O Port	Bus	Timer (MTU3, GPT, POE3, CAC)	Communications (SCIc, SCId, RSPI, RIIC, CAN)	Interrupt	S12ADB, AD, DA
38		PB0	A14	MTIOC0D	MOSIA/MOSIB		
39		PA5		MTIOC1A	RXD0/SMISO0/ SSCL0/ MISOA/MISOB		ADTRG1#
40		PA4		MTIOC1B	TXD0/SMOSI0/ SSDA0/RSPCKA/ RSPCKB		ADTRG0#
41		PA3		MTIOC2A	SCK0/SSLA0/SSLB0		
42		PA2		MTIOC2B	RXD2/SMISO2/ SSCL2/ SSLA1/SSLB1		
43		PA1		MTIOC6A	TXD2/SMOSI2/ SSDA2/SSLA2/SSLB2		
44		PA0		MTIOC6C	SCK2/SSLA3/SSLB3		
45	VCC						
46		P96	A13	POE4#	RXD1/SMISO1/SSCL1	IRQ4-DS	
47	VSS						
48		P95		MTIOC6B/ GTIOC4A	TXD1/SMOSI1/SSDA1		
49		P94		MTIOC7A/ GTIOC5A	CTS1#/RTS1#/SS1#		
50		P93		MTIOC7B/ GTIOC6A	CTS2#/RTS2#/SS2#		
51		P92		MTIOC6D/GTIOC4B			
52		P91		MTIOC7C/GTIOC5B			
53		P90		MTIOC7D/GTIOC6B			
54	TRCLK	PG5		POE12#	SCK3		ADTRG#
55	TRDATA3	PG4		GTIOC6B	RXD3/SMISO3/SSCL3	IRQ6	
56	TRDATA2	PG3		GTIOC6A	TXD3/SMOSI3/SSDA3		
57	TRDATA1	PG2			SCK2	IRQ2	
58	TRDATA0	PG1		GTIOC7B	RXD2/SMISO2/SSCL2	IRQ1	
59	TRSYNC	PG0		GTIOC7A	TXD2/SMOSI2/SSDA2	IRQ0	
60		P76	D0/[A0/D0]	MTIOC4D/GTIOC2B			
61		P75	D1/[A1/D1]	MTIOC4C/GTIOC1B			
62		P74	D2/[A2/D2]	MTIOC3D/GTIOC0B			
63		P73	D3/[A3/D3]	MTIOC4B/GTIOC2A			
64		P72	D4/[A4/D4]	MTIOC4A/GTIOC1A			
65		P71	D5/[A5/D5]	MTIOC3B/GTIOC0A			
66		P70	D6/[A6/D6]	POE0#	CTS1#/RTS1#/SS1#	IRQ5-DS	
67		P33	D7/[A7/D7]	MTIOC3A/MTCLKA	SSLA3/SSLB3		
68		P32	D8/[A8/D8]	MTIOC3C/MTCLKB	SSLA2/SSLB2		
69	VCC						
70		P31	D9/[A9/D9]	MTIOC0A/MTCLKC	SSLA1/SSLB1		
71	VSS						
72		P30	D10/[A10/ D10]	MTIOC0B/MTCLKD	SCK0/SSLA0/SSLB0		
73		P24	D11/[A11/D11]		CTS0#/RTS0#/SS0#/ RSPCKA/RSPCKB	IRQ4	

2. CPU

The RX CPU has sixteen general-purpose registers, nine control registers, and one accumulator used for DSP instructions.

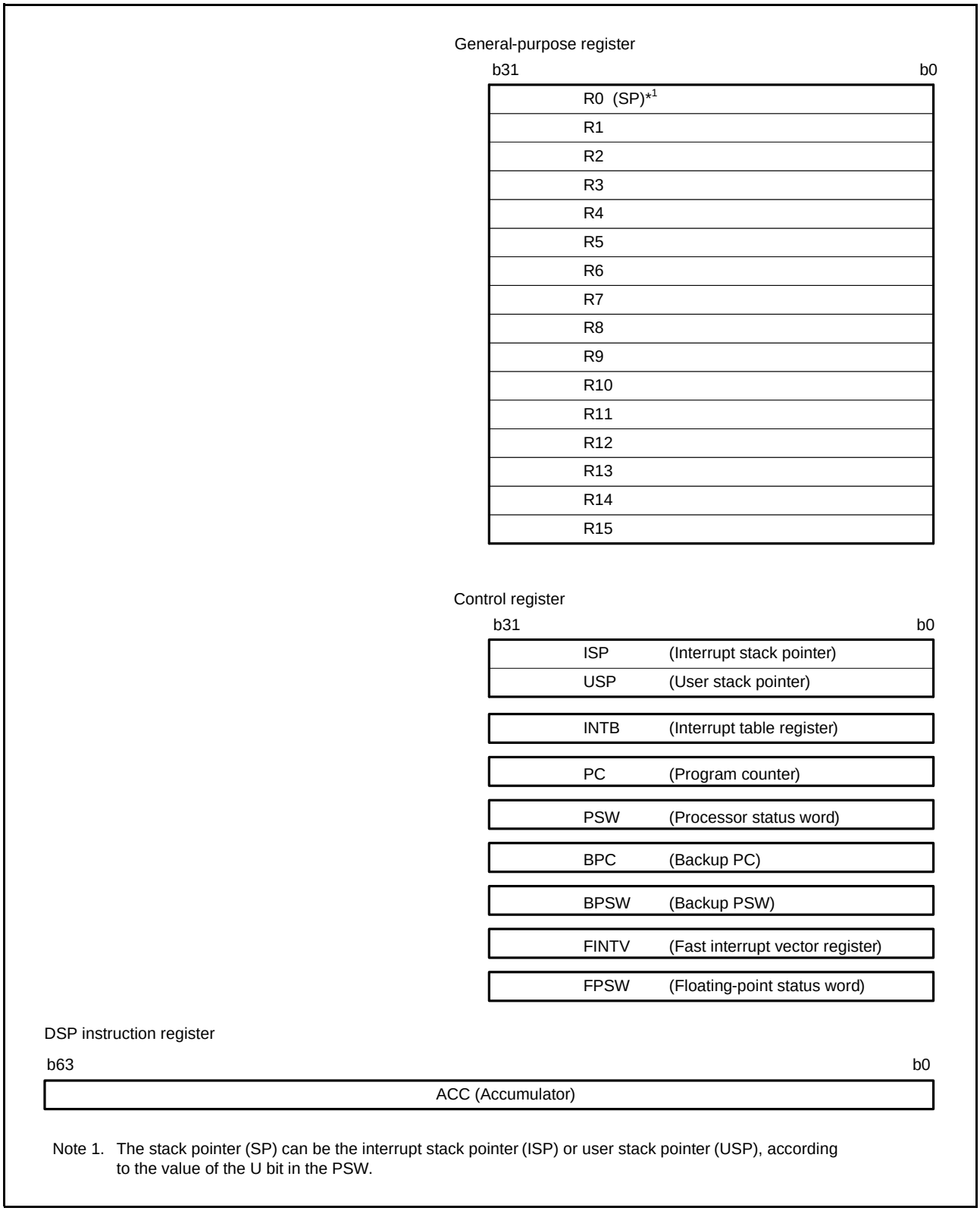


Figure 2.1 Register Set of the CPU

4. I/O Registers

This section gives information on the on-chip I/O register addresses. The information is given as shown below. Notes on writing to registers are also given at the end.

(1) I/O register addresses (address order)

- Registers are listed from the lower allocation addresses.
- Registers are classified according to module symbols.
- The number of access cycles indicates the number of cycles based on the specified reference clock.
- Among the internal I/O register area, addresses not listed in the list of registers are reserved. Reserved addresses must not be accessed. Do not access these addresses; otherwise, the operation when accessing these bits and subsequent operations cannot be guaranteed.

(2) Notes on writing to I/O registers

When writing to an I/O register, the CPU starts executing the subsequent instruction before completing I/O register write. This may cause the subsequent instruction to be executed before the post-update I/O register value is reflected on the operation.
As described in the following examples, special care is required for the cases in which the subsequent instruction must be executed after the post-update I/O register value is actually reflected.

[Examples of cases requiring special care]

- The subsequent instruction must be executed while an interrupt request is disabled with the IENj bit in IERn of the ICU (interrupt request enable bit) cleared to 0.
- A WAIT instruction is executed immediately after the preprocessing for causing a transition to the low power consumption state.

In the above cases, after writing to an I/O register, wait until the write operation is completed using the following procedure and then execute the subsequent instruction.

(a) Write to an I/O register.
(b) Read the value from the I/O register to a general register.
(c) Execute the operation using the value read.
(d) Execute the subsequent instruction.

[Instruction examples]

- Byte-size I/O registers

```
MOV.L  #SFR_ADDR, R1
MOV.B  #SFR_DATA, [R1]
CMP    [R1].UB, R1
;; Next process
```

- Word-size I/O registers

```
MOV.L  #SFR_ADDR, R1
MOV.W  #SFR_DATA, [R1]
CMP    [R1].W, R1
;; Next process
```

Table 4.1 List of I/O Registers (Address Order) (2/48)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Module Name	Remarks
						ICLK ≥ PCLK	ICLK < PCLK		
0008 201Fh	DMAC0	DMA Activation Source Flag Control Register	DMCSL	8	8	2 ICLK		DMACA	
0008 2040h	DMAC1	DMA Source Address Register	DMSAR	32	32	2 ICLK			
0008 2044h	DMAC1	DMA Destination Address Register	DMDAR	32	32	2 ICLK			
0008 2048h	DMAC1	DMA Transfer Count Register	DMCRA	32	32	2 ICLK			
0008 204Ch	DMAC1	DMA Block Transfer Count Register	DMCRB	16	16	2 ICLK			
0008 2050h	DMAC1	DMA Transfer Mode Register	DMTMD	16	16	2 ICLK			
0008 2053h	DMAC1	DMA Interrupt Setting Register	DMINT	8	8	2 ICLK			
0008 2054h	DMAC1	DMA Address Mode Register	DMAMD	16	16	2 ICLK			
0008 205Ch	DMAC1	DMA Transfer Enable Register	DMCNT	8	8	2 ICLK			
0008 205Dh	DMAC1	DMA Software Start Register	DMREQ	8	8	2 ICLK			
0008 205Eh	DMAC1	DMA Status Register	DMSTS	8	8	2 ICLK			
0008 205Fh	DMAC1	DMA Activation Source Flag Control Register	DMCSL	8	8	2 ICLK			
0008 2080h	DMAC2	DMA Source Address Register	DMSAR	32	32	2 ICLK			
0008 2084h	DMAC2	DMA Destination Address Register	DMDAR	32	32	2 ICLK			
0008 2088h	DMAC2	DMA Transfer Count Register	DMCRA	32	32	2 ICLK			
0008 208Ch	DMAC2	DMA Block Transfer Count Register	DMCRB	16	16	2 ICLK			
0008 2090h	DMAC2	DMA Transfer Mode Register	DMTMD	16	16	2 ICLK			
0008 2093h	DMAC2	DMA Interrupt Setting Register	DMINT	8	8	2 ICLK			
0008 2094h	DMAC2	DMA Address Mode Register	DMAMD	16	16	2 ICLK			
0008 209Ch	DMAC2	DMA Transfer Enable Register	DMCNT	8	8	2 ICLK			
0008 209Dh	DMAC2	DMA Software Start Register	DMREQ	8	8	2 ICLK			
0008 209Eh	DMAC2	DMA Status Register	DMSTS	8	8	2 ICLK			
0008 209Fh	DMAC2	DMA Activation Source Flag Control Register	DMCSL	8	8	2 ICLK			
0008 20C0h	DMAC3	DMA Source Address Register	DMSAR	32	32	2 ICLK			
0008 20C4h	DMAC3	DMA Destination Address Register	DMDAR	32	32	2 ICLK			
0008 20C8h	DMAC3	DMA Transfer Count Register	DMCRA	32	32	2 ICLK			
0008 20CCh	DMAC3	DMA Block Transfer Count Register	DMCRB	16	16	2 ICLK			
0008 20D0h	DMAC3	DMA Transfer Mode Register	DMTMD	16	16	2 ICLK			
0008 20D3h	DMAC3	DMA Interrupt Setting Register	DMINT	8	8	2 ICLK			
0008 20D4h	DMAC3	DMA Address Mode Register	DMAMD	16	16	2 ICLK			
0008 20DCh	DMAC3	DMA Transfer Enable Register	DMCNT	8	8	2 ICLK			
0008 20DDh	DMAC3	DMA Software Start Register	DMREQ	8	8	2 ICLK			
0008 20DEh	DMAC3	DMA Status Register	DMSTS	8	8	2 ICLK			
0008 20DFh	DMAC3	DMA Activation Source Flag Control Register	DMCSL	8	8	2 ICLK			
0008 2200h	DMAC	DMACA Module Activation Register	DMAST	8	8	2 ICLK			
0008 2400h	DTC	DTC Control Register	DTCCR	8	8	2ICLK		DTCa	
0008 2404h	DTC	DTC Vector Base Register	DTCVBR	32	32	2ICLK			
0008 2408h	DTC	DTC Address Mode Register	DTCADMOD	8	8	2ICLK			
0008 240Ch	DTC	DTC Module Start Register	DTCST	8	8	2ICLK			
0008 240Eh	DTC	DTC Status Register	DTCSTS	16	16	2ICLK			
0008 3002h	BSC	CS0 Mode Register	CS0MOD	16	16	1, 2 BCLK		Buses	Not present in versions with 64 or 48 pins.
0008 3004h	BSC	CS0 Wait Control Register 1	CS0WCR1	32	32	1, 2 BCLK			Not present in versions with 64 or 48 pins.
0008 3008h	BSC	CS0 Wait Control Register 2	CS0WCR2	32	32	1, 2 BCLK			Not present in versions with 64 or 48 pins.
0008 3012h	BSC	CS1 Mode Register	CS1MOD	16	16	1, 2 BCLK			Not present in versions with 64 or 48 pins.
0008 3014h	BSC	CS1 Wait Control Register 1	CS1WCR1	32	32	1, 2 BCLK			Not present in versions with 64 or 48 pins.
0008 3018h	BSC	CS1 Wait Control Register 2	CS1WCR2	32	32	1, 2 BCLK			Not present in versions with 64 or 48 pins.
0008 3022h	BSC	CS2 Mode Register	CS2MOD	16	16	1, 2 BCLK			Not present in versions with 64 or 48 pins.

Table 4.1 List of I/O Registers (Address Order) (15/48)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Module Name	Remarks
						ICLK ≥ PCLK	ICLK < PCLK		
0008 8308h	RIIC0	I²C Bus Status Register 1	ICSR1	8	8	2, 3 PCLKB	2 ICLK	RIIC	
0008 8309h	RIIC0	I²C Bus Status Register 2	ICSR2	8	8	2, 3 PCLKB	2 ICLK		
0008 830Ah	RIIC0	Slave Address Register L0	SARL0	8	8	2, 3 PCLKB	2 ICLK		
0008 830Ah	RIIC0	Timeout Internal Counter L	TMOCNTL	8	8	2, 3 PCLKB	2 ICLK		
0008 830Bh	RIIC0	Slave Address Register U0	SARU0	8	8	2, 3 PCLKB	2 ICLK		
0008 830Bh	RIIC0	Timeout Internal Counter U	TMOCNTU	8	8*2	2, 3 PCLKB	2 ICLK		
0008 830Ch	RIIC0	Slave Address Register L1	SARL1	8	8	2, 3 PCLKB	2 ICLK		
0008 830Dh	RIIC0	Slave Address Register U1	SARU1	8	8	2, 3 PCLKB	2 ICLK		
0008 830Eh	RIIC0	Slave Address Register L2	SARL2	8	8	2, 3 PCLKB	2 ICLK		
0008 830Fh	RIIC0	Slave Address Register U2	SARU2	8	8	2, 3 PCLKB	2 ICLK		
0008 8310h	RIIC0	I²C Bus Bit Rate Low-Level Register	ICBRL	8	8	2, 3 PCLKB	2 ICLK		
0008 8311h	RIIC0	I²C Bus Bit Rate High-Level Register	ICBRH	8	8	2, 3 PCLKB	2 ICLK		
0008 8312h	RIIC0	I²C Bus Transmit Data Register	ICDRT	8	8	2, 3 PCLKB	2 ICLK		
0008 8313h	RIIC0	I²C Bus Receive Data Register	ICDRR	8	8	2, 3 PCLKB	2 ICLK		
0008 8320h	RIIC1	I²C Bus Control Register 1	ICCR1	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 8321h	RIIC1	I²C Bus Control Register 2	ICCR2	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 8322h	RIIC1	I²C Bus Mode Register 1	ICMR1	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 8323h	RIIC1	I²C Bus Mode Register 2	ICMR2	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 8324h	RIIC1	I²C Bus Mode Register 3	ICMR3	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 8325h	RIIC1	I²C Bus Function Enable Register	ICFER	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 8326h	RIIC1	I²C Bus Status Enable Register	ICSER	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 8327h	RIIC1	I²C Bus Interrupt Enable Register	ICIER	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 8328h	RIIC1	I²C Bus Status Register 1	ICSR1	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 8329h	RIIC1	I²C Bus Status Register 2	ICSR2	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 832Ah	RIIC1	Slave Address Register L0	SARL0	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 832Ah	RIIC1	Timeout Internal Counter L	TMOCNTL	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 832Bh	RIIC1	Slave Address Register U0	SARU0	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 832Bh	RIIC1	Timeout Internal Counter U	TMOCNTU	8	8*2	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 832Ch	RIIC1	Slave Address Register L1	SARL1	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 832Dh	RIIC1	Slave Address Register U1	SARU1	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 832Eh	RIIC1	Slave Address Register L2	SARL2	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 832Fh	RIIC1	Slave Address Register U2	SARU2	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.

Table 4.1 List of I/O Registers (Address Order) (20/48)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Module Name	Remarks
						ICLK ≥ PCLK	ICLK < PCLK		
0008 9873h	AD	A/D Sampling State Register 1	ADSSTR1	8	8	2, 3 PCLKB	2 ICLK	AD	Not present in versions with 64 or 48 pins.
0008 9874h	AD	A/D Sampling State Register 2	ADSSTR2	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9875h	AD	A/D Sampling State Register 3	ADSSTR3	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9876h	AD	A/D Sampling State Register 4	ADSSTR4	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9877h	AD	A/D Sampling State Register 5	ADSSTR5	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9878h	AD	A/D Sampling State Register 6	ADSSTR6	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9879h	AD	A/D Sampling State Register 7	ADSSTR7	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 987Dh	AD	Digital Power Supply Control Circuit Output Register	ADDPCONR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64, or 48 pins.
0008 A000h	SCI0	Serial Mode Register	SMR	8	8	2, 3 PCLKB	2 ICLK	SCIc, SCId	
0008 A001h	SCI0	Bit Rate Register	BRR	8	8	2, 3 PCLKB	2 ICLK		
0008 A002h	SCI0	Serial Control Register	SCR	8	8	2, 3 PCLKB	2 ICLK		
0008 A003h	SCI0	Transmit Data Register	TDR	8	8	2, 3 PCLKB	2 ICLK		
0008 A004h	SCI0	Serial Status Register	SSR	8	8	2, 3 PCLKB	2 ICLK		
0008 A005h	SCI0	Receive Data Register	RDR	8	8	2, 3 PCLKB	2 ICLK		
0008 A006h	SCI0	Smart Card Mode Register	SCMR	8	8	2, 3 PCLKB	2 ICLK		
0008 A007h	SCI0	Serial Extended Mode Register	SEMR	8	8	2, 3 PCLKB	2 ICLK		
0008 A008h	SCI0	Noise Filter Setting Register	SNFR	8	8	2, 3 PCLKB	2 ICLK		
0008 A009h	SCI0	I^2C Mode Register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK		
0008 A00Ah	SCI0	I^2C Mode Register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK		
0008 A00Bh	SCI0	I^2C Mode Register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK		
0008 A00Ch	SCI0	I^2C Status Register	SISR	8	8	2, 3 PCLKB	2 ICLK		
0008 A00Dh	SCI0	SPI Mode Register	SPMR	8	8	2, 3 PCLKB	2 ICLK		
0008 A020h	SCI1	Serial Mode Register	SMR	8	8	2, 3 PCLKB	2 ICLK		
0008 A021h	SCI1	Bit Rate Register	BRR	8	8	2, 3 PCLKB	2 ICLK		
0008 A022h	SCI1	Serial Control Register	SCR	8	8	2, 3 PCLKB	2 ICLK		
0008 A023h	SCI1	Transmit Data Register	TDR	8	8	2, 3 PCLKB	2 ICLK		
0008 A024h	SCI1	Serial Status Register	SSR	8	8	2, 3 PCLKB	2 ICLK		
0008 A025h	SCI1	Receive Data Register	RDR	8	8	2, 3 PCLKB	2 ICLK		
0008 A026h	SCI1	Smart Card Mode Register	SCMR	8	8	2, 3 PCLKB	2 ICLK		
0008 A027h	SCI1	Serial Extended Mode Register	SEMR	8	8	2, 3 PCLKB	2 ICLK		
0008 A028h	SCI1	Noise Filter Setting Register	SNFR	8	8	2, 3 PCLKB	2 ICLK		
0008 A029h	SCI1	I^2C Mode Register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK		
0008 A02Ah	SCI1	I^2C Mode Register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK		
0008 A02Bh	SCI1	I^2C Mode Register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK		
0008 A02Ch	SCI1	I^2C Status Register	SISR	8	8	2, 3 PCLKB	2 ICLK		
0008 A02Dh	SCI1	SPI Mode Register	SPMR	8	8	2, 3 PCLKB	2 ICLK		
0008 A040h	SCI2	Serial Mode Register	SMR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 A041h	SCI2	Bit Rate Register	BRR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 A042h	SCI2	Serial Control Register	SCR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 A043h	SCI2	Transmit Data Register	TDR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 A044h	SCI2	Serial Status Register	SSR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 A045h	SCI2	Receive Data Register	RDR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 A046h	SCI2	Smart Card Mode Register	SCMR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.

Table 4.1 List of I/O Registers (Address Order) (32/48)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Module Name	Remarks
						ICLK ≥ PCLK	ICLK < PCLK		
000A 006Ch	USB0	Pipe Maximum Packet Size Register	PIPEMAXP	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1	USBa	Not present in versions with 112, 100, 64, or 48 pins.
000A 006Eh	USB0	Pipe Cycle Control Register	PIPEPERI	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 0070h	USB0	PIPE1 Control Register	PIPE1CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 0072h	USB0	PIPE2 Control Register	PIPE2CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 0074h	USB0	PIPE3 Control Register	PIPE3CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 0076h	USB0	PIPE4 Control Register	PIPE4CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 0078h	USB0	PIPE5 Control Register	PIPE5CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 007Ah	USB0	PIPE6 Control Register	PIPE6CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 007Ch	USB0	PIPE7 Control Register	PIPE7CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 007Eh	USB0	PIPE8 Control Register	PIPE8CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 0080h	USB0	PIPE9 Control Register	PIPE9CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.
000A 0090h	USB0	PIPE1 Transaction Counter Enable Register	PIPE1TRE	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/(frequency ratio of ICLK/PCLKB)*1		Not present in versions with 112, 100, 64, or 48 pins.

Table 4.1 List of I/O Registers (Address Order) (40/48)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Module Name	Remarks
						ICLK ≥ PCLK	ICLK < PCLK		
000C 2230h	GPT2	A/D Converter Start Request Timing Double-Buffer Register B	GTADTDBRB	16	16, 32	2 to 5 PCLKA	2, 3 ICLK	GPT	
000C 2234h	GPT2	General PWM Timer Output Negate Control Register	GTONCR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2236h	GPT2	General PWM Timer Dead Time Control Register	GTDTCR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2238h	GPT2	General PWM Timer Dead Time Value Register U	GTDVU	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 223Ah	GPT2	General PWM Timer Dead Time Value Register D	GTDVD	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 223Ch	GPT2	General PWM Timer Dead Time Buffer Register U	GTDBU	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 223Eh	GPT2	General PWM Timer Dead Time Buffer Register D	GTDBD	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2240h	GPT2	General PWM Timer Output Protection Function Status Register	GTSOS	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2242h	GPT2	General PWM Timer Output Protection Function Temporary Release Register	GTSOTR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2280h	GPT3	General PWM Timer I/O Control Register	GTIOR	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2282h	GPT3	General PWM Timer Interrupt Output Setting Register	GTINTAD	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2284h	GPT3	General PWM Timer Control Register	GTCR	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2286h	GPT3	General PWM Timer Buffer Enable Register	GTBER	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2288h	GPT3	General PWM Timer Count Direction Register	GTUDC	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 228Ah	GPT3	General PWM Timer Interrupt and A/D Converter Start Request Skipping Setting Register	GTITC	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 228Ch	GPT3	General PWM Timer Status Register	GTST	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 228Eh	GPT3	General PWM Timer Counter	GTCNT	16	16	2 to 5 PCLKA	2, 3 ICLK		
000C 2290h	GPT3	General PWM Timer Compare Capture Register A	GTCCRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2292h	GPT3	General PWM Timer Compare Capture Register B	GTCCRB	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2294h	GPT3	General PWM Timer Compare Capture Register C	GTCCRC	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2296h	GPT3	General PWM Timer Compare Capture Register D	GTCCRD	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2298h	GPT3	General PWM Timer Compare Capture Register E	GTCCRE	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 229Ah	GPT3	General PWM Timer Compare Capture Register F	GTCCRF	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 229Ch	GPT3	General PWM Timer Cycle Setting Register	GTPR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 229Eh	GPT3	General PWM Timer Cycle Setting Buffer Register	GTPBR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 22A0h	GPT3	General PWM Timer Cycle Setting Double-Buffer Register	GTPDBR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 22A4h	GPT3	A/D Converter Start Request Timing Register A	GTADTRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 22A6h	GPT3	A/D Converter Start Request Timing Buffer Register A	GTADTBRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 22A8h	GPT3	A/D Converter Start Request Timing Double-Buffer Register A	GTADTDBRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 22ACh	GPT3	A/D Converter Start Request Timing Register B	GTADTRB	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 22AEh	GPT3	A/D Converter Start Request Timing Buffer Register B	GTADTBRB	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 22B0h	GPT3	A/D Converter Start Request Timing Double-Buffer Register B	GTADTDBRB	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 22B4h	GPT3	General PWM Timer Output Negate Control Register	GTONCR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 22B6h	GPT3	General PWM Timer Dead Time Control Register	GTDTCR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 22B8h	GPT3	General PWM Timer Dead Time Value Register U	GTDVU	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		

Table 4.1 List of I/O Registers (Address Order) (48/48)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Module Name	Remarks
						ICLK ≥ PCLK	ICLK < PCLK		
007F FFB0h	FLASH	Flash Status Register 0	FSTATR0	8	8	2, 3 FCLK	2, 3 ICLK	ROM	
007F FFB1h	FLASH	Flash Status Register 1	FSTATR1	8	8	2, 3 FCLK	2, 3 ICLK		
007F FFB2h	FLASH	Flash P/E Mode Entry Register	FENTRYR	16	16	2, 3 FCLK	2, 3 ICLK	ROM/ E2 DataFlash Memory	
007F FFB4h	FLASH	Flash Protection Register	FPROTR	16	16	2, 3 FCLK	2, 3 ICLK	ROM	
007F FFB6h	FLASH	Flash Reset Register	FRESETR	16	16	2, 3 FCLK	2, 3 ICLK		
007F FFBAh	FLASH	FCU Command Register	FCMDR	16	16	2, 3 FCLK	2, 3 ICLK		
007F FFC8h	FLASH	FCU Processing Switching Register	FCPSR	16	16	2, 3 FCLK	2, 3 ICLK		
007F FFCAh	FLASH	E2 DataFlash Blank Check Control Register	DFLBCCNT	16	16	2, 3 FCLK	2, 3 ICLK	E2 DataFlash Memory	
007F FFCCh	FLASH	Flash P/E Status Register	FPESTAT	16	16	2, 3 FCLK	2, 3 ICLK	ROM	
007F FFCEh	FLASH	E2 DataFlash Blank Check Status Register	DFLBCSTAT	16	16	2, 3 FCLK	2, 3 ICLK	E2 DataFlash Memory	
007F FFE8h	FLASH	Peripheral Clock Notification Register	PCKAR	16	16	2, 3 FCLK	2, 3 ICLK	ROM	

Note: • This table shows the maximum specifications of I/O registers. The I/O registers of individual products correspond to the list of functions given as Table 1.2. For details, refer to Table 1.2, Comparison of Functions for Different Packages.
Note 1. When the register is accessed while the USB is operating, a delay may be generated in accessing.
Note 2. Odd addresses are not accessible in 16-bit units. Obtain 16-bit access to the two registers by access to the address of TMOCNTL.
Note 3. Pins USB0 and RIIC1 are not present in 112-pin products.
Note 4. Pins USB0, RIIC1, and SCI3 are not present in 100-pin products.
Note 5. Pins GPT4 to GPT7, USB0, RSPI1, RIIC1, SCI2, SCI3, CAN1, AD, and S12AD1 are not present in 64- and 48-pin products.

5. Electrical Characteristics [144-, 120-, 112- and 100-Pin Versions]

5.1 Absolute Maximum Ratings

Table 5.1 Absolute Maximum Ratings

Conditions: VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V

Item		Symbol	Value	Unit
Power supply voltage		VCC, PLLVCC	–0.3 to +6.5	V
USB power supply voltage		VCC_USB*1	–0.3 to +6.5	V
Analog power supply voltage		AVCC0, AVCC*2	–0.3 to +6.5	V
Reference power supply voltage		VREFH0*2	–0.3 to AVCC0 + 0.3	V
		VREF*2	–0.3 to AVCC0 + 0.3	V
Input voltage (except for ports 4 to 6, C, USB0_DP, and USB0_DM)		V_{in}	–0.3 to VCC + 0.3	V
Input voltage (USB0_DP and USB0_DM)		V_{in}	–0.3 to VCC_USB + 0.3	V
Input voltage (port 4)		V_{in}	–0.3 to AVCC0 + 0.3	V
Input voltage (ports 5, 6, and C)		V_{in}	–0.3 to AVCC + 0.3	V
Analog input voltage (port 4)		V_{AN}	–0.3 to AVCC0 + 0.3	V
Analog input voltage (ports 5, 6, and C)		V_{AN}	–0.3 to AVCC + 0.3	V
Operating temperature	D version product	T_{opr}	–40 to +85	ºC
	G version product	T_{opr}	–40 to +105	ºC
Storage temperature		T_{stg}	–55 to +125	ºC

Caution: Permanent damage to the LSI may result if absolute maximum ratings are exceeded.

Note 1. When the USB is not in use, do not leave the VCC_USB and VSS_USB pins open.
Connect the VCC_USB pin to VCC, and the VSS_USB pin to VSS, respectively.

Note 2. When the A/D converter is not in use, do not leave the AVCC0, VREFH0, VREFL0, AVSS0, AVCC, VREF, and AVSS pins open.
- When the 12-bit A/D converter is not in use
  Connect the AVCC0 pin to AVCC, the VREFH0 pin to VREF, and the AVSS0 and VREFL0 pins to AVSS, respectively.
- When the 10-bit A/D converter is not in use
  Connect the AVCC pin to AVCC0, the VREF pin to VREFH0, and the AVSS pin to AVSS0, respectively.
- When the 12-bit A/D converter and 10-bit A/D converter are not in use
  Connect the AVCC0, VREFH0, AVCC, and VREF pins to VCC, and the AVSS0, VREFL0, and AVSS pins to VSS, respectively.

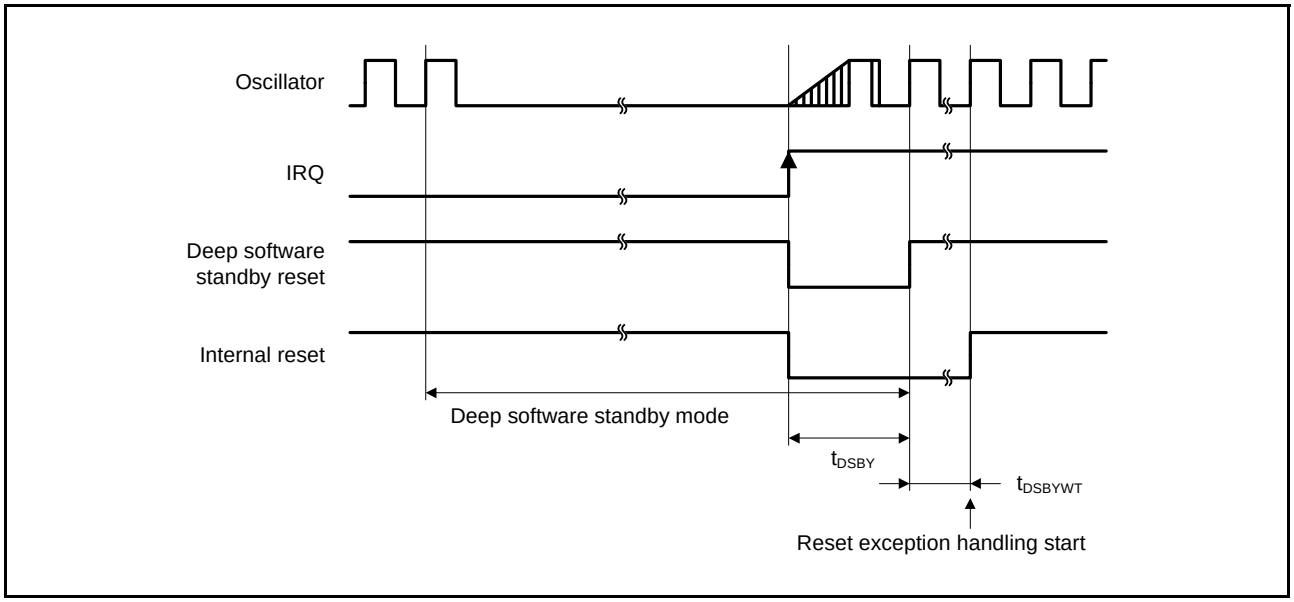


Figure 5.10 Deep Software Standby Mode Cancellation Timing

5.3.5 Bus Timing

Table 5.12 Bus Timing (1)

Condition: VCC = PLLVCC = VCC_USB = AVCC0 = AVCC = 3.0 to 3.6 V,
VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC
$T_a = T_{opr}$
Output load conditions: V_{OH} = VCC x 0.5, V_{OL} = VCC x 0.5, I_{OH} = –1.0 mA, I_{OL} = 1.0 mA, C = 30 pF

Item	Symbol	Min.	Max.	Unit	Test Conditions
Address delay time	t_{AD}	—	30	ns	Figure 5.13 to Figure 5.16
Byte control delay time	t_{BCD}	—	30	ns	
CS# delay time	t_{CSD}	—	30	ns	
RD# delay time	t_{RSD}	—	30	ns	
Read data setup time	t_{RDS}	20	—	ns	
Read data hold time	t_{RDH}	0	—	ns	
WR# delay time	t_{WRD}	—	30	ns	
Write data delay time	t_{WDD}	—	35	ns	
Write data hold time	t_{WDH}	0	—	ns	
WAIT# setup time	t_{WTS}	20	—	ns	Figure 5.17
WAIT# hold time	t_{WTH}	0	—	ns	

Table 5.13 Bus Timing (2)

Condition: VCC = PLLVCC = AVCC0 = AVCC = 4.0 to 5.5 V, VCC_USB = 3.0 to 3.6 V,
VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
$T_a = T_{opr}$
Output load conditions: V_{OH} = VCC x 0.5, V_{OL} = VCC x 0.5, I_{OH} = –1.0 mA, I_{OL} = 1.0 mA, C = 30 pF

Item	Symbol	Min.	Max.	Unit	Test Conditions
Address delay time	t_{AD}	—	15	ns	Figure 5.13 to Figure 5.16
Byte control delay time	t_{BCD}	—	15	ns	
CS# delay time	t_{CSD}	—	15	ns	
RD# delay time	t_{RSD}	—	15	ns	
Read data setup time	t_{RDS}	15	—	ns	
Read data hold time	t_{RDH}	0	—	ns	
WR# delay time	t_{WRD}	—	15	ns	
Write data delay time	t_{WDD}	—	15	ns	
Write data hold time	t_{WDH}	0	—	ns	
WAIT# setup time	t_{WTS}	15	—	ns	Figure 5.17
WAIT# hold time	t_{WTH}	0	—	ns	

Table 5.16 Timing of On-Chip Peripheral Modules (5)

Note: Common standard values for conditions not given in the table are listed as “Condition 1” to “Condition 3” below.

Condition 1: VCC = PLLVCC = VCC_USB = 2.7 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0

Condition 2: VCC = PLLVCC = VCC_USB = 2.7 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VCC_USB = 3.0 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0

$T_a = T_{opr}$. T_a is common to conditions 1 to 3.

Item		Symbol	Min.*1,*2	Max.	Unit	Test Conditions
RIIC (Standard-mode)	SCL input cycle time	t_{SCL}	$6(12) \times t_{IICcyc} + 1300$	—	ns	Figure 5.36
	SCL input high pulse width	t_{SCLH}	$3(6) \times t_{IICcyc} + 300$	—	ns	
	SCL input low pulse width	t_{SCLL}	$3(6) \times t_{IICcyc} + 300$	—	ns	
	SCL, SDA input rise time	t_{Sr}	—	1000	ns	
	SCL, SDA input fall time	t_{Sf}	—	300	ns	
	SCL, SDA input spike pulse removal time	t_{SP}	0	$1(4) \times t_{IICcyc}$	ns	
	SDA input bus free time	t_{BUF}	$3(6) \times t_{IICcyc} + 300$	—	ns	
	Start condition input hold time	t_{STAH}	$t_{IICcyc} + 300$	—	ns	
	Restart condition input setup time	t_{STAS}	1000	—	ns	
	Stop condition input setup time	t_{STOS}	1000	—	ns	
	Data input setup time	t_{SDAS}	$t_{IICcyc} + 50$	—	ns	
	Data input hold time	t_{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C_b	—	400	pF	
RIIC (Fast-mode)	SCL input cycle time	t_{SCL}	$6(12) \times t_{IICcyc} + 600$	—	ns	
	SCL input high pulse width	t_{SCLH}	$3(6) \times t_{IICcyc} + 300$	—	ns	
	SCL input low pulse width	t_{SCLL}	$3(6) \times t_{IICcyc} + 300$	—	ns	
	SCL, SDA input rise time	t_{Sr}	$20 + 0.1C_b$	300	ns	
	SCL, SDA input fall time	t_{Sf}	$20 + 0.1C_b$	300	ns	
	SCL, SDA input spike pulse removal time	t_{SP}	0	$1(4) \times t_{IICcyc}$	ns	
	SDA input bus free time	t_{BUF}	$3(6) \times t_{IICcyc} + 300$	—	ns	
	Start condition input hold time	t_{STAH}	$t_{IICcyc} + 300$	—	ns	
	Restart condition input setup time	t_{STAS}	300	—	ns	
	Stop condition input setup time	t_{STOS}	300	—	ns	
	Data input setup time	t_{SDAS}	$t_{IICcyc} + 50$	—	ns	
	Data input hold time	t_{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C_b	—	400	pF	

Note: • t_{IICcyc}: RIIC internal reference clock (IICϕ) cycle

Note 1. The value within parentheses is applicable when the value of the ICMR3.NF[1:0] bits is 11b while the digital filter is enabled by the setting ICFER.NFE = 1.

Note 2. Cb is the total capacitance of the bus lines.

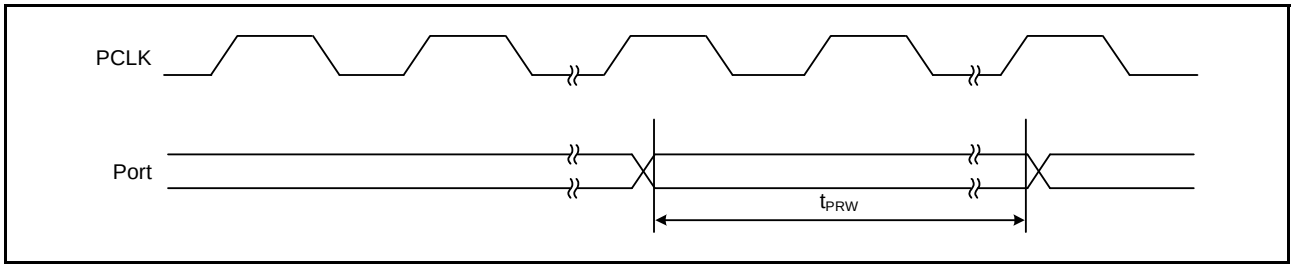


Figure 5.20 I/O port Input Timing

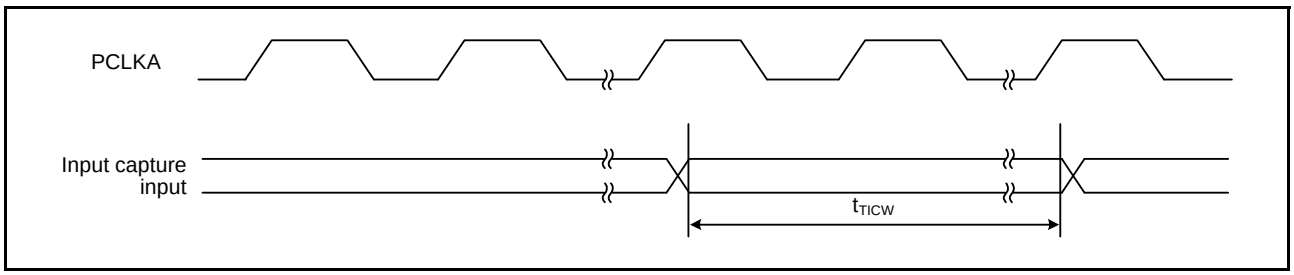


Figure 5.21 MTU3 Input/Output Timing

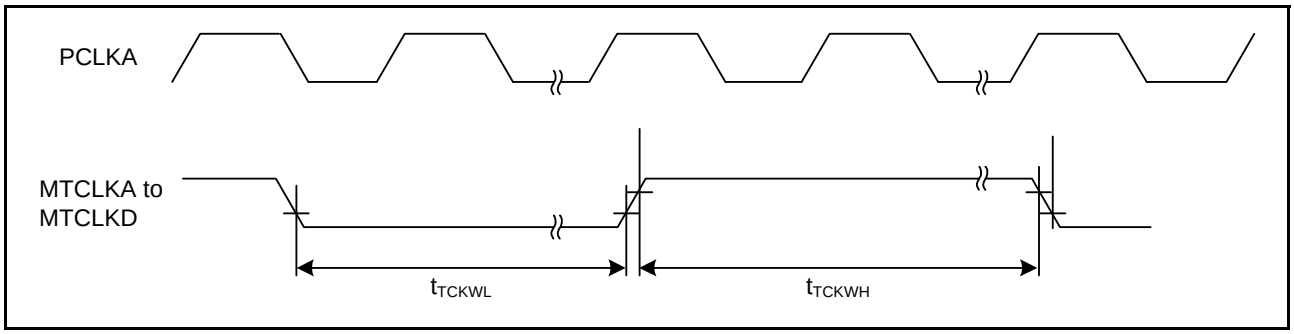


Figure 5.22 MTU3 Clock Input Timing

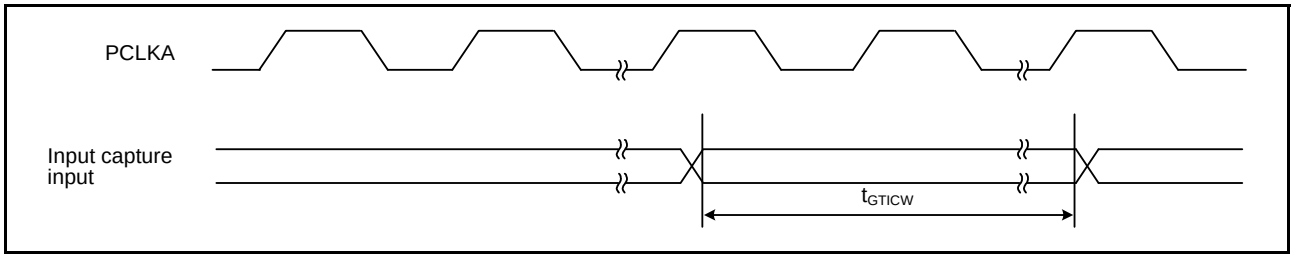


Figure 5.23 GPT Input Capture Input Timing

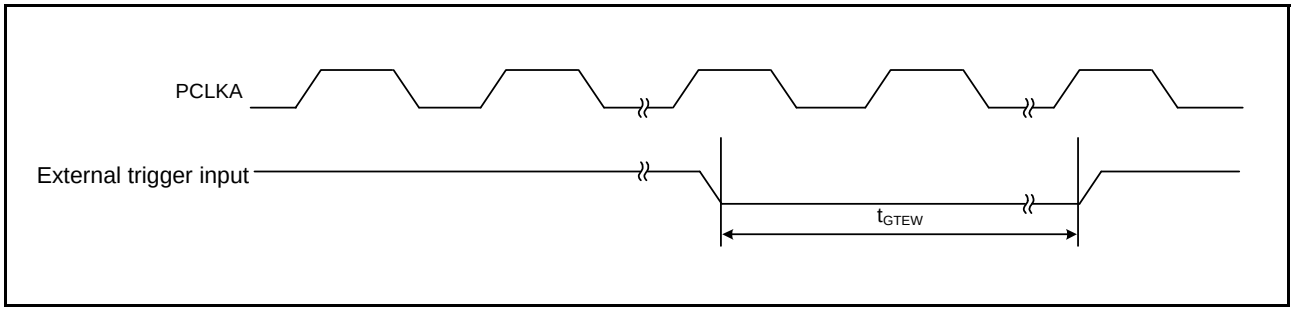


Figure 5.24 GPT External Trigger Input Timing

Table 6.13 Timing of On-Chip Peripheral Modules (3)

Conditions: VCC = 2.7 to 3.6 V, VSS = AVSS0 = VREFL0 = 0 V,
AVCC0 = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0,
Ta = T_{opr}

Item		Symbol	Min.	Max.	Unit*1	Test Conditions
Simple SPI	SCK clock cycle output (master)	t_{SPcyc}	4	65536	t_{Pcyc}	Figure 6.20
	SCK clock cycle input (slave)		8	65536		
	SCK clock high pulse width	t_{SPCKWH}	0.4	0.6	t_{SPcyc}	
	SCK clock low pulse width	t_{SPCKWL}	0.4	0.6	t_{SPcyc}	
	SCK clock rise/fall time	t_{SPCKR}, t_{SPCKF}	—	20	ns	
	Data input setup time	t_{SU}	40	—	ns	Figure 6.21 to Figure 6.24
	Data input hold time	t_{H}	40	—	ns	
	SS input setup time	t_{LEAD}	6	—	t_{Pcyc}	
	SS input hold time	t_{LAG}	6	—	t_{Pcyc}	
	Data output delay time	t_{OD}	—	40	ns	
	Data output hold time	t_{OH}	–10	—	ns	
	Data rise/fall time	t_{DR}, t_{DF}	—	20	ns	
	SS input rise/fall time	t_{SSLr}, t_{SSLf}	—	20	ns	
	Slave access time	t_{SA}	—	5	t_{Pcyc}	Figure 6.23 and Figure 6.24
	Slave output release time	t_{REL}	—	5	t_{Pcyc}	

Note 1. t_{Pcyc}: PCLK cycle

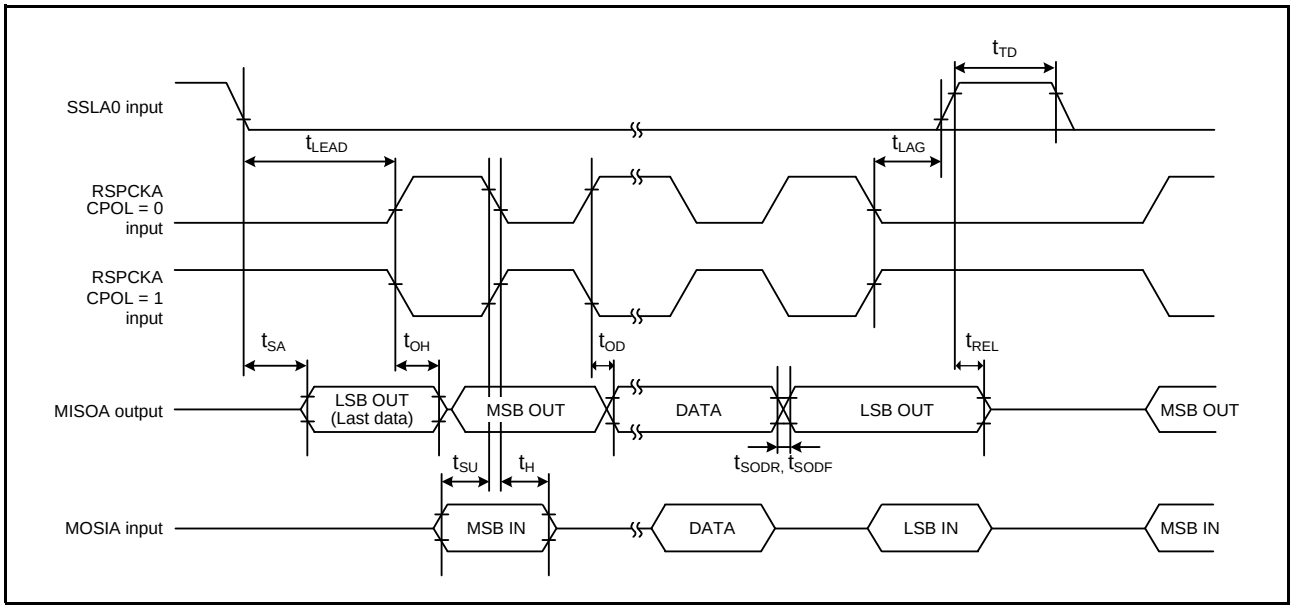
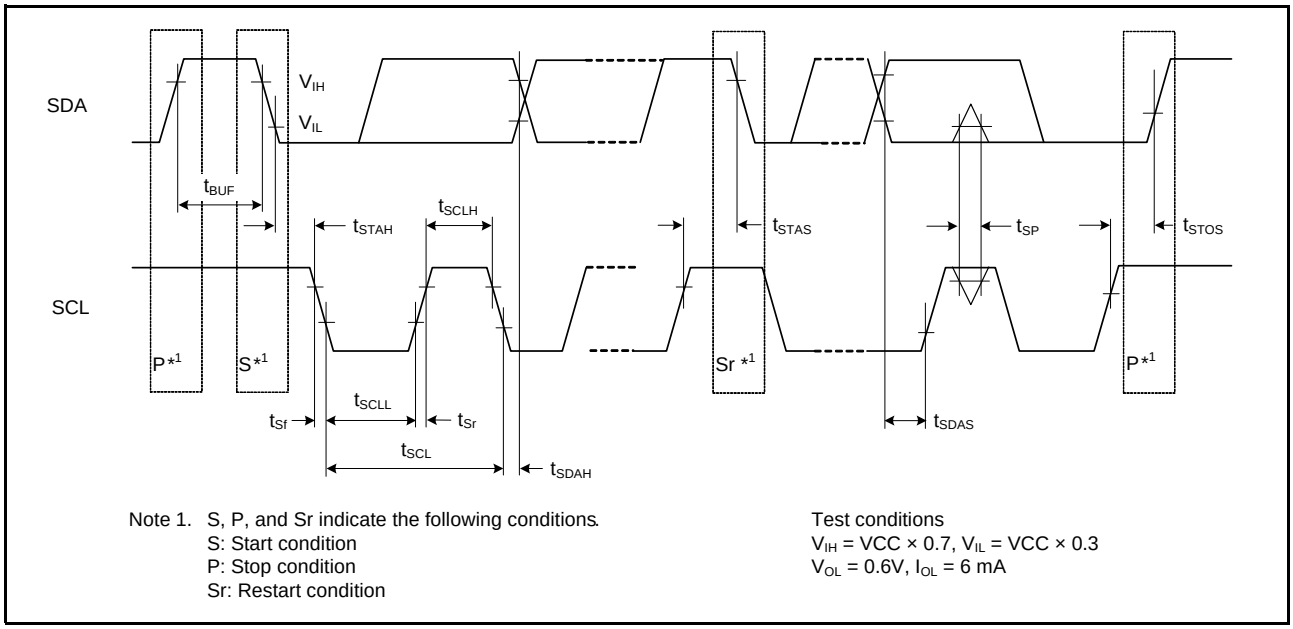


Figure 6.24 RSPI Timing (Slave, CPHA = 1) and Simple SPI Timing (Slave, CKPH = 0)



Note 1. S, P, and Sr indicate the following conditions.
S: Start condition
P: Stop condition
Sr: Restart condition

Test conditions
V_{IH} = VCC × 0.7, V_{IL} = VCC × 0.3
V_{OL} = 0.6V, I_{OL} = 6 mA

Figure 6.25 RIIC Bus Interface Input/Output Timing and Simple IIC Bus Interface Input/Output Timing

6.8 E^2 DataFlash Characteristic

Table 6.22 E^2 DataFlash (Flash Memory for Data Storage) Characteristics (1)

Conditions: VCC = 2.7 to 3.6 V, VSS = AVSS0 = VREFL0 = 0 V
AVCC0 = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0
Temperature range for the programming/erasure operation: $T_a = T_{opr}$. T_a is common to conditions 1 to 3.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Reprogram/erase cycle*1	N_{DPEC}	100000	—	—	Times	
Data hold time	t_{DDRP}	30*2	—	—	Year	Ta = +85°C

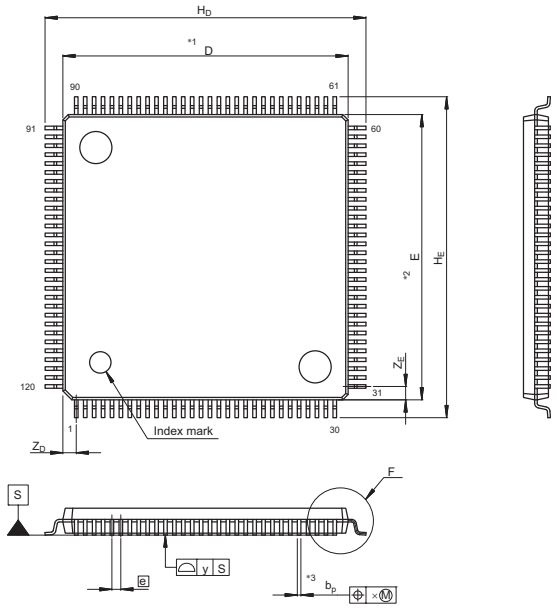
Note 1. Definition of reprogram/erase cycle:
The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 1000), erasing can be performed n times for each block. For instance, when 128-byte programming is performed 16 times for different addresses in 2-Kbyte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).
Note 2. The value is obtained from the reliability test.

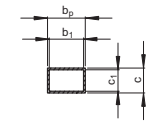
Table 6.23 E^2 DataFlash (Flash Memory for Data Storage) Characteristics (2)

Conditions: VCC = 2.7 to 3.6 V, VSS = AVSS0 = VREFL0 = 0 V,
AVCC0 = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0,
Ta = T_{opr}

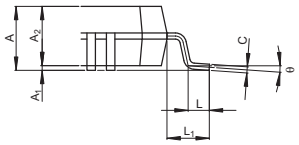
Item		Symbol	min	typ	max	Unit	Test Condition
Programming time	2 bytes	t_{DP2}	—	0.25	2	ms	FCLK = 50 MHz
Erasure time	32 bytes	t_{DE32}	—	2	20	ms	FCLK = 50 MHz $N_{DPEC} \leq 100$
	32 bytes	t_{DE32}	—	4	20	ms	FCLK = 50 MHz $N_{DPEC} > 100$
Blank check time	2 bytes	t_{DBC2}	—	—	30	µs	FCLK = 50 MHz
Suspend delay time during programming		t_{DSPD}	—	—	120	µs	Figure 6.31 PCLKB = 50 MHz
First suspend delay time during erasing (in suspend priority mode)		t_{DSESD1}	—	—	120	µs	
Second suspend delay time during erasing (in suspend priority mode)		t_{DSESD2}	—	—	300	µs	
Suspend delay time during erasing (in erasure priority mode)		t_{DSEED}	—	—	300	µs	

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LQFP120-16x16-0.50	PLQP0120KA-A	—	0.9g





Terminal cross section



Detail F

NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	15.9	16.0	16.1
E	15.9	16.0	16.1
A_2	—	1.4	—
H_D	17.8	18.0	18.2
H_E	17.8	18.0	18.2
A	—	—	1.7
A_1	0.05	0.1	0.15
b_p	0.17	0.22	0.27
b_1	—	0.20	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.5	—
x	—	—	0.08
y	—	—	0.08
Z_D	—	0.75	—
Z_E	—	0.75	—
L	0.35	0.5	0.65
L_1	—	1.0	—

Figure B 120-Pin LQFP (PLQP0120KA-A)

Rev.	Date	Description	
		Page	Summary
2.10	Sep 26, 2013	36 to 39	Table 1.7 List of Pins and Pin Functions (112-Pin LQFP), changed
		40 to 42	Table 1.8 List of Pins and Pin Functions (100-Pin LQFP), changed
		43 to 45	Table 1.9 List of Pins and Pin Functions (64-Pin LQFP), changed
		46 to 47	Table 1.10 List of Pins and Pin Functions (48-Pin LQFP), changed
		4. I/O Registers	
		56 to 103	Table 4.1 List of I/O Registers (Address Order), changed
		5. Electrical Characteristics [144-, 120-, 112- and 100-Pin Versions]	
		104	Table 5.1 Absolute Maximum Ratings, changed
		107	Table 5.4 DC Characteristics (3), Note 7, deleted
		108	Table 5.6 Permissible Power Consumption, added
		128	5.3.7 Timing of PWM Delay Generation Circuit, added
		128	Table 42.21 Timing of the PWM Delay Generation Circuit, added
		132	Figure 5.32 RSPI Timing (Master, CPHA = 1) (Bit Rate: PCLKB Division Ratio Set to a Value Other Than 1/2) and Simple SPI Timing (Master, CKPH = 1), changed
		133	Figure 5.34 RSPI Timing (Slave, CPHA = 0) and Simple SPI Timing (Slave, CKPH = 0), changed
		134	Figure 5.35 RSPI Timing (Slave, CPHA = 1) and Simple SPI Timing (Slave, CKPH = 1), changed
		6. Electrical Characteristics [64- and 48-Pin Versions]	
		149	Table 6.1 Absolute Maximum Ratings, changed
		151	Table 6.3 DC Characteristics (2), Note 3, changed
		152	Table 6.5 Permissible Power Consumption, added

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

   Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

   ¾ The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

   The state of the product is undefined at the moment when power is supplied.

   ¾ The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
   In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.
   In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

   Access to reserved addresses is prohibited.

   ¾ The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

   After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

   ¾ When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

   Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

   ¾ The characteristics of Microprocessing unit or Microcontroller unit products in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.